2-1470109-2 - ACTIVE

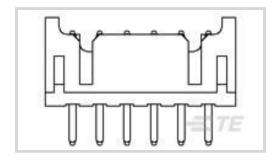
AMPMODU | AMPMODU 2 mm

TE Internal #: 2-1470109-2 PCB Mount Header, Vertical, Wire-to-Board, 22 Position, 2 mm [. 079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm

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Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 22

Number of Rows: 2

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Vertical

Features

Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No

Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Board-to-Board Configuration	Parallel	
Connector Contact Load Condition	Fully Loaded	
Number of Positions	22	
Number of Rows	2	
PCB Mount Orientation	Vertical	
Electrical Characteristics		
Dielectric Withstanding Voltage (Max)	750 VAC	
Insulation Resistance	5000 MΩ	
Operating Voltage	100 VDC	
Body Features		
Primary Product Color	Natural	
Contact Features		

PCB Mount Header, Vertical, Wire-to-Board, 22 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm



Contact Mating Area Length	3 mm[.1 in][.138 in]
Mating Square Post Dimension	.5 mm[.02 in]
	100 µin
Contact Mating Area Plating Material Thickness	2.54 μm[100 μin]
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Post & Tail Length	3 mm[.118 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Keyed
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	2 mm[.079 in]
Dimensions	
Connector Height	6.5 mm
PCB Thickness (Recommended)	1.57 mm[.062 in]
Row-to-Row Spacing	2 mm[.079 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
ndustry Standards	

PCB Mount Header, Vertical, Wire-to-Board, 22 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm



Approved Standards	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Type	Bag, Carton	
Other		
Position Locations Omitted	0	
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant	
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC	
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free	

Solder Process Capability

Not lead free process capable

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

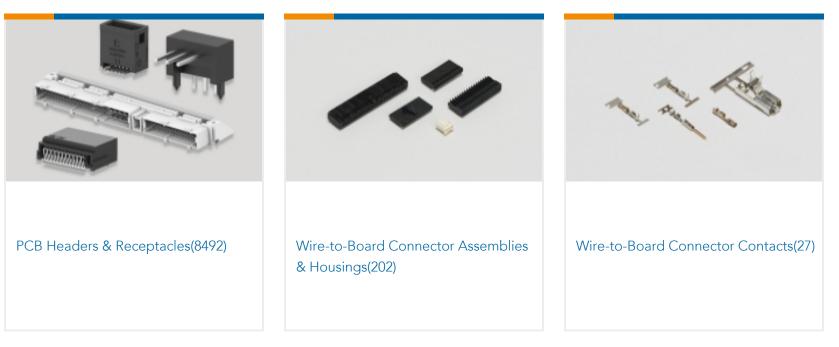
Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 22 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm





Also in the Series | AMPMODU 2 mm



Customers Also Bought



TE Part #6609056-1 3MV1=F7756 S0	TE Part #7-215464-8 08P.MICRO-MATCH MOB	TE Part #6609020-4 2EB3=F7101 S0	TE Part #106505-2 9P.HDP20 REC.ASSY.
TE Part #440129-9 2.0MM,HSG,9POS	TE Part #6-1437719-0 T01-0560-S05-FEMALE REC PANEL- PCB MNT RA	TE Part #8-215460-2 MICRO-MATCH FSID P	TE Part #825433-2 MOD 2 PINHDR 1X2 P.



TE Part #1077624003 HFT5000-25/12-0-SP

PCB Mount Header, Vertical, Wire-to-Board, 22 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, AMPMODU 2 mm



Documents

Product Drawings 2.0mm Pitch Header,Dip 22p

English

CAD Files

Customer View Model ENG_CVM_CVM_2-1470109-2_E.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-1470109-2_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-1470109-2_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION3AND4

English

HPI Connectors QRG

English

Product Specifications

Product Specification

English

Product Specification

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